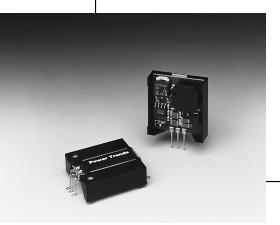
78HT200

#### 2 AMP POSITIVE STEP-DOWN **INTEGRATED SWITCHING REGULATOR**

## **Revised 9/22/99**

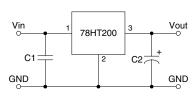


- High Efficiency > 82%
- Wide Input Range
- Self-Contained Inductor
- **Short-Circuit Protection**
- Over-Temperature Protection
- Fast Transient Response

The 78HT200 is a series of wide input voltage, 3 terminal Integrated Switching Regulators (ISRs). Employing a ceramic substrate, these ISRs have a maximum output current of 2A. The output voltage is laser trimmed for high accuracy.

The 78HT200 series regulators have internal short-circuit and overtemperature protection and may be used in a wide variety of applications.

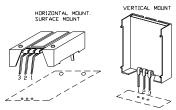
# **Standard Application**



C1 = Optional 1µF ceramic C2 = Required 100µF electrolytic

#### **Pin-Out Information**

Pin No.	Function
1	$V_{in}$
2	GND
3	V <sub>out</sub>



SUGGESTED BOARD LAYOUT

# **Ordering Information**

78HT2 | **XX** | Output Voltage Package Suffix

V = Vertical Mount

**S** = Surface Mount

**H** = Horizontal

Mount

**33** = 3.3 Volts

**46** = 4.6 Volts

05 = 5.0 Volts

**53** = 5.25 Volts

**65** = 6.5 Volts75 = 7.5 Volts

10 = 10.0 Volts

(For dimensions and PC board layout see Package Style 500.)

## **Specifications**

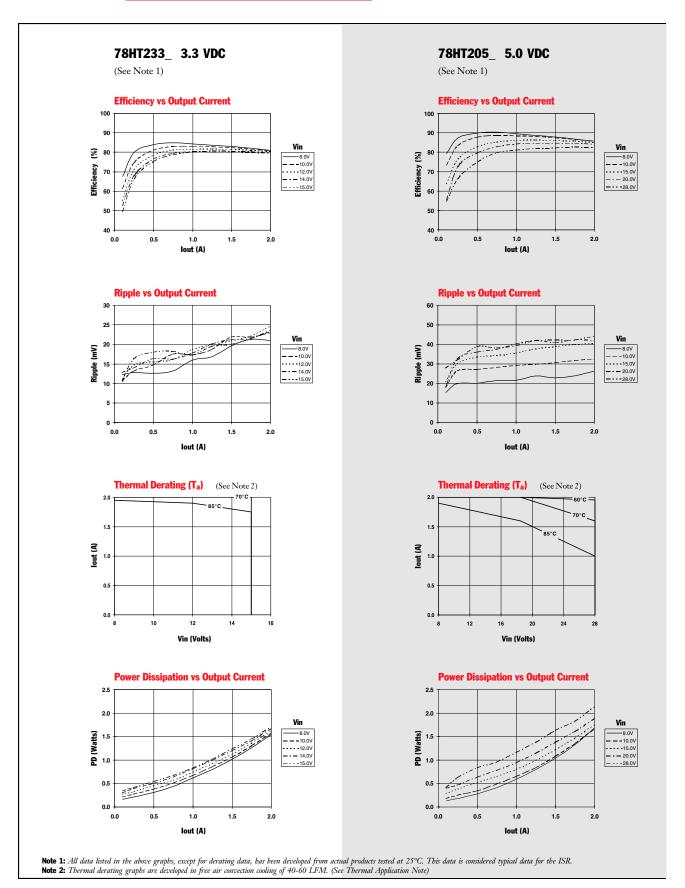
Characteristics			78HT200 SERIES			
(T <sub>a</sub> = 25°C unless noted)	Symbols	Conditions	Min	Тур	Max	Units
Output Current	$I_{o}$	Over V <sub>in</sub> range	0.1*	_	2.0	A
Input Voltage Range	$V_{in}$	$I_o$ = 0.1 to 2.0A $V_o$ < 4.6V $V_o$ $\geq$ 4.6V	7 V <sub>o</sub> +2V	_	15 28	V V
Output Voltage Tolerance	$\Delta { m V}_{ m o}$	Over $V_{in}$ range, $I_{o}$ = 2.0A $T_{a}$ = 0°C to +60°C	_	±1.0	±2.0	%Vo
Line Regulation	Reg <sub>line</sub>	Over V <sub>in</sub> range	_	±0.4	±0.8	$%V_{o}$
Load Regulation	Regload	$0.1 \le I_o \le 2.0A$	_	±0.2	±0.4	$%V_{o}$
Ripple/Noise	$V_n$	$V_{in}$ = $V_{in}$ min, $I_o$ = 2.0A	_	1	_	%Vo
Transient Response (with 100µF output cap)	t <sub>tr</sub>	50% load change $ m V_o$ over/undershoot	_	100 5.0	_	μSec %V <sub>o</sub>
Efficiency	η	$V_{in} = 9V$ , $I_o = 2.0A$ , $V_o = 5V$	_	82	_	%
Switching Frequency	$f_{0}$	Over $V_{in}$ and $I_o$ ranges $V_o \ge 4.6 V$ $V_o = 3.3 V$	700 0.95	750 1.0	800 1.05	kHz MHz
Absolute Maximum Operating Temperature Range	$T_a$	-	-40	_	+85	°C
Recommended Operating Temperature Range	$T_a$	Free Air Convection, (40-60LFM) Over $V_{\rm in}$ and $I_{\rm o}$ ranges	-40	_	+85**	°C
Thermal Resistance	$\theta_{\mathrm{ja}}$	Free Air Convection, (40-60LFM)	_	38	_	°C/W
Storage Temperature	$T_s$	_	-40		+125	°C
Mechanical Shock	_	Per Mil-STD-883D, Method 2002.3	_	500	_	G's
Mechanical Vibration	_	Per Mil-STD-883D, Method 2007.2, 20-2000 Hz, soldered in a PC board	_	5	_	G's
Weight	_	_	_	7	_	Grams

<sup>\*</sup> ISR will operate down to no load with reduced specifications.

Note: The 78HT200 Series requires a 100µF electrolytic or tantalum output capacitor for proper operation in all applications.

<sup>\*\*</sup> See Thermal Derating chart.

#### CHARACTERISTIC DATA





11-Nov-2009 www.ti.com

# **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
78HT205HC	NRND	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
78HT205SC	NRND	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
78HT205TC	NRND	SIP MOD ULE	EFT	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
78HT205VC	NRND	SIP MOD ULE	EFD	3	25	TBD	Call TI	Level-1-215C-UNLIM
78HT210HC	OBSOLETE	SIP MOD ULE	EFA	3		TBD	Call TI	Call TI
78HT210SC	OBSOLETE	SIP MOD ULE	EFC	3		TBD	Call TI	Call TI
78HT210VC	OBSOLETE	SIP MOD ULE	EFD	3		TBD	Call TI	Call TI
78HT233HC	NRND	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
78HT233SC	NRND	SIP MOD ULE	EFC	3		TBD	Call TI	Call TI
78HT233VC	NRND	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
78HT246HC	OBSOLETE	SIP MOD ULE	EFA	3		TBD	Call TI	Call TI
78HT246SC	OBSOLETE	SIP MOD ULE	EFC	3		TBD	Call TI	Call TI
78HT246VC	OBSOLETE	SIP MOD ULE	EFD	3		TBD	Call TI	Call TI
78HT253SC	OBSOLETE	SIP MOD ULE	EFC	3		TBD	Call TI	Call TI
78HT253VC	OBSOLETE	SIP MOD ULE	EFD	3		TBD	Call TI	Call TI
78HT265HC	NRND	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
78HT265SC	OBSOLETE	SIP MOD ULE	EFC	3		TBD	Call TI	Call TI
78HT265TC	NRND	SIP MOD ULE	EFT	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
78HT265VC	OBSOLETE	SIP MOD ULE	EFD	3		TBD	Call TI	Call TI
78HT275HC	OBSOLETE	SIP MOD ULE	EFA	3		TBD	Call TI	Call TI
78HT275SC	OBSOLETE	SIP MOD ULE	EFC	3		TBD	Call TI	Call TI
78HT275VC	OBSOLETE	SIP MOD ULE	EFD	3		TBD	Call TI	Call TI

(1) The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.



#### PACKAGE OPTION ADDENDUM

www.ti.com 11-Nov-2009

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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